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*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
EMJ	5,567,663	10/1996	KOTANI et al.			
EMJ	5,370,920	12/1994	FORSYTHE et al.			
EMJ	4,869,944	09/1989	HARADA et al.			
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*Examiner /Edward M. Johnson/ (03/02/2007) Date Considered

Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to application.